

General Description

The AGM55N15C combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

Application

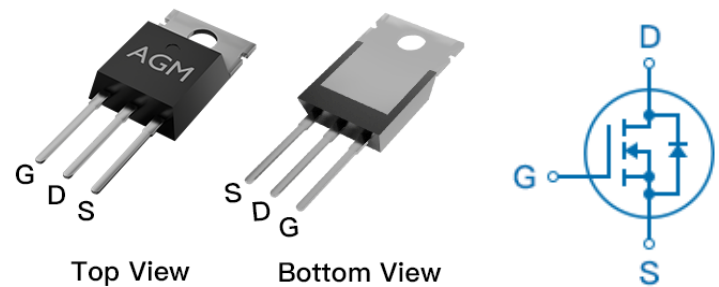
- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Package Marking and Ordering Information

Product Summary

BVDSS	RDSON	ID
150V	52mΩ	28A

TO-220 Pin Configuration



Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM55N15C	AGM55N15C	TO-220	---	---	1000

Table 1. Absolute Maximum Ratings (TA=25°C)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	150	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) (Note 1)	28	A
	Drain Current-Continuous(Tc=100°C)	19	A
IDM (pluse)	Drain Current-Pulsed (Note 2)	112	A
PD	Maximum Power Dissipation(Tc=25°C)	73	w
	Maximum Power Dissipation(Tc=100°C)	29	w
EAS	Avalanche energy (Note 3)	51	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹	--	60	°C/W
RθJC	Thermal Resistance Junction-Case ¹	--	1.7	°C/W

Table 3. Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	150	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=150V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2.5	3.3	4.2	V
gFS	Forward Transconductance	VDS=5V,ID=10A	--	10	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A	--	52	60	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=40V,VGS=0V, F=1MHZ	--	440	--	pF
Coss	Output Capacitance		--	171	--	pF
Crss	Reverse Transfer Capacitance		--	7.5	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	1.2	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=10V,VDS=75V, RL=8Ω,RGEN=6Ω	--	4.3	--	nS
tr	Turn-on Rise Time		--	3.5	--	nS
td(off)	Turn-Off Delay Time		--	7.6	--	nS
tf	Turn-Off Fall Time		--	3.5	--	nS
Qg	Total Gate Charge	VGS=0V, VDS=75V, ID=9A	--	3.6	--	nC
Qgs	Gate-Source Charge		--	1.6	--	nC
Qgd	Gate-Drain Charge		--	1.9	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)	TC=25℃	--	--	28	A
VSD	Forward on Voltage	VGS=0V,IS=20A	--	--	1.2	V
trr	Reverse Recovery Time	IF=20A , dl/dt=100A/μs	--	75	--	ns
Qrr	Reverse Recovery Charge	,TJ=25℃	--	98	--	nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: T_J=25°C,VDD=50V,Vgs=10V,ID=32A,L=0.1mH,RG=25ohm

Typical Electrical & Thermal Characteristics

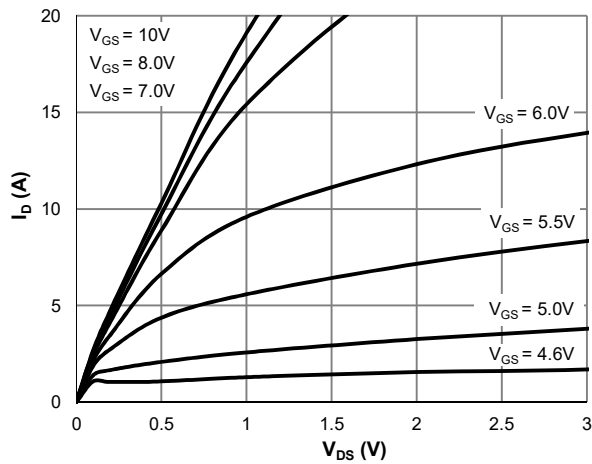


Figure 1: Saturation Characteristics

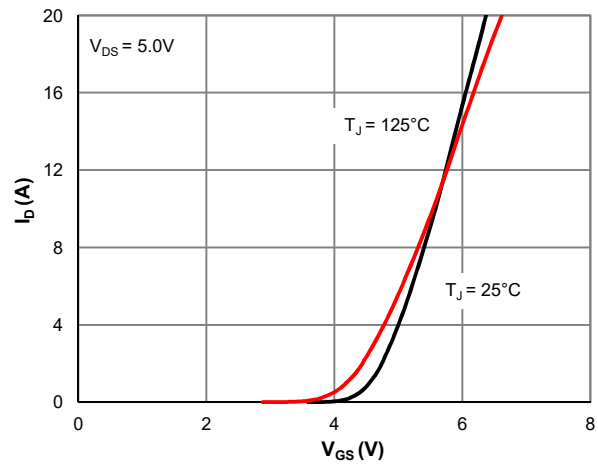


Figure 2: Transfer Characteristics

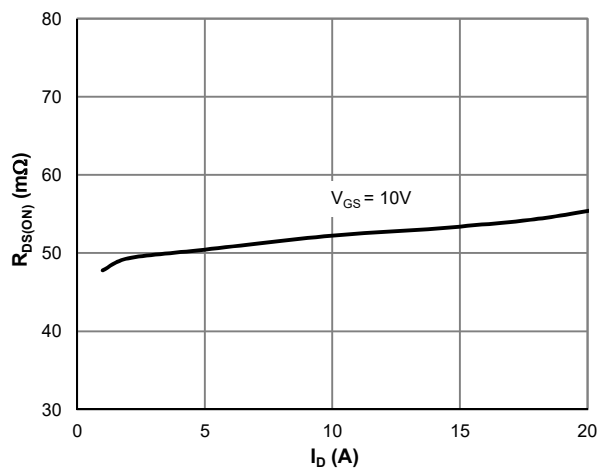


Figure 3: $R_{DS(ON)}$ vs. Drain Current

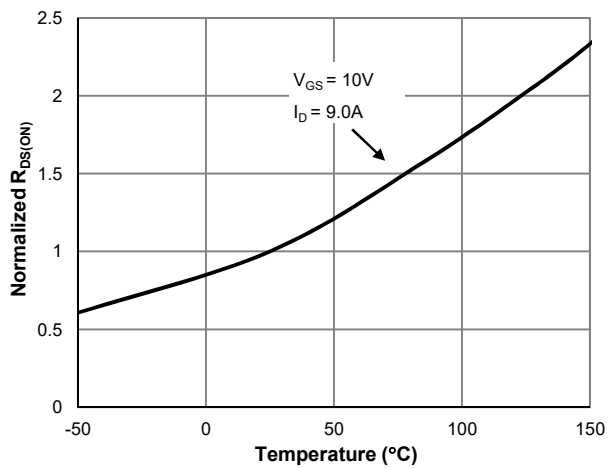


Figure 4: $R_{DS(ON)}$ vs. Junction Temperature

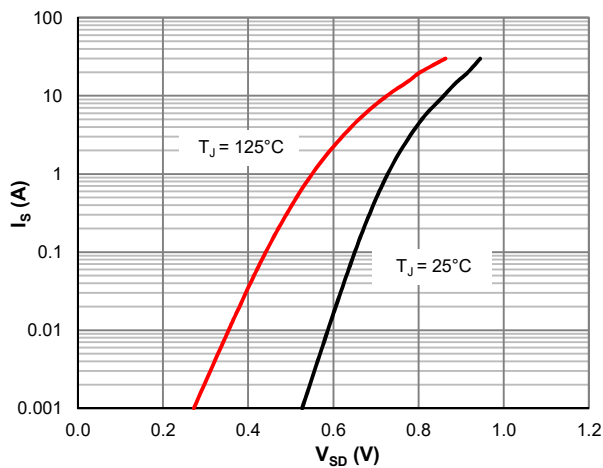


Figure 5: Body-Diode Characteristics

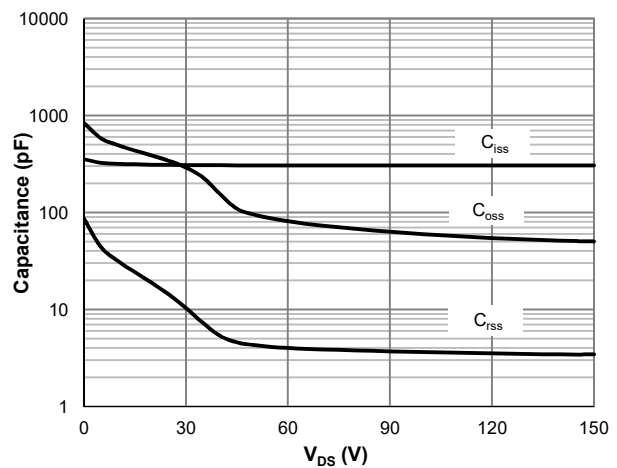


Figure 6: Capacitance Characteristics

Typical Electrical & Thermal Characteristics

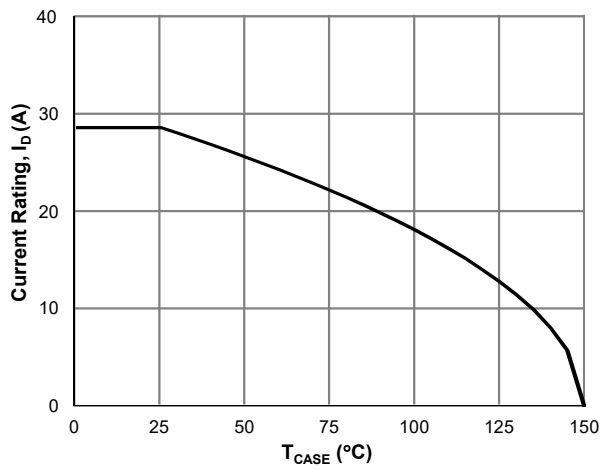


Figure 7: Current De-rating

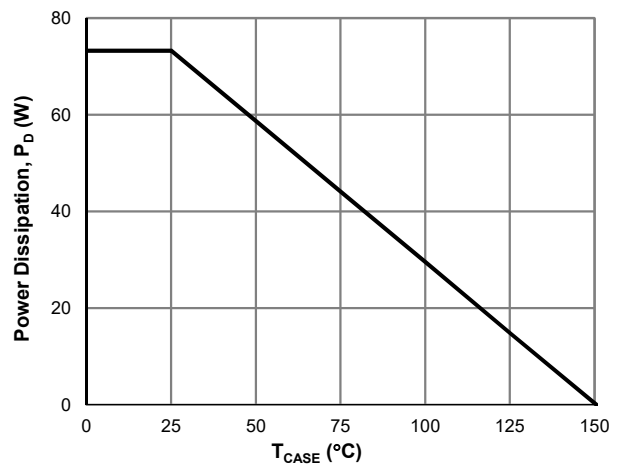


Figure 8: Power De-rating

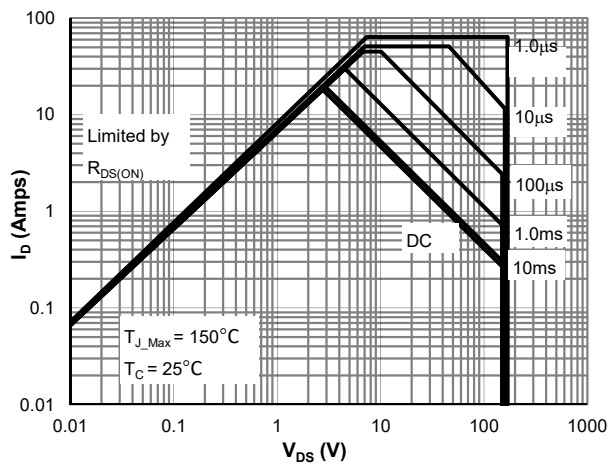


Figure 9: Maximum Safe Operating Area

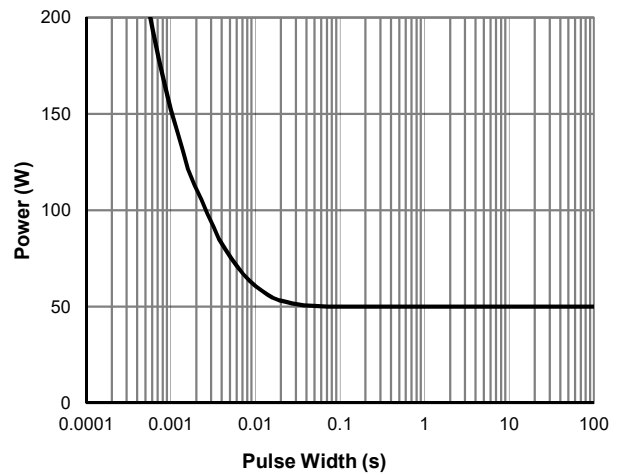


Figure 10: Single Pulse Power Rating, Junction-to-Case

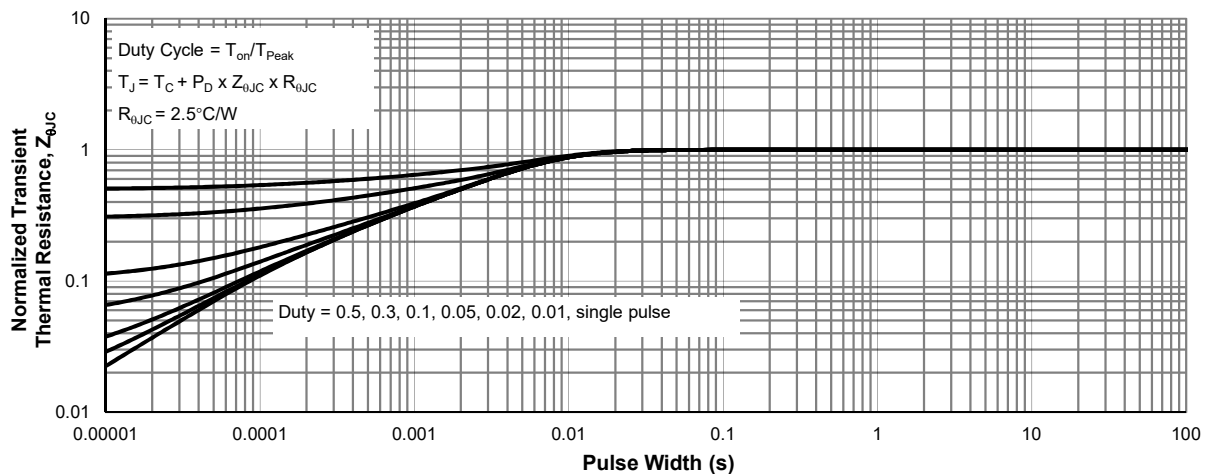
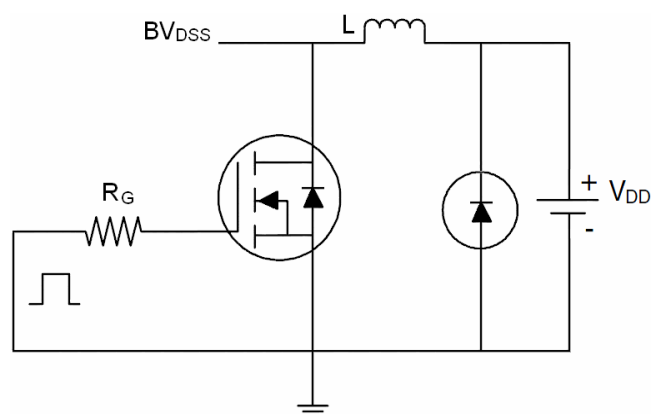
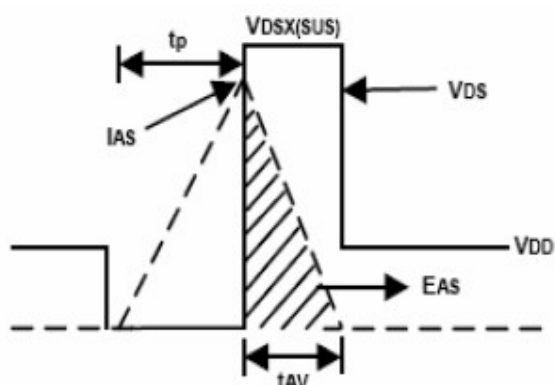


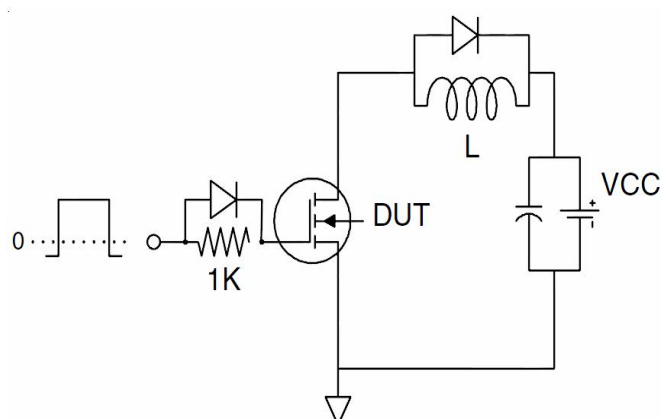
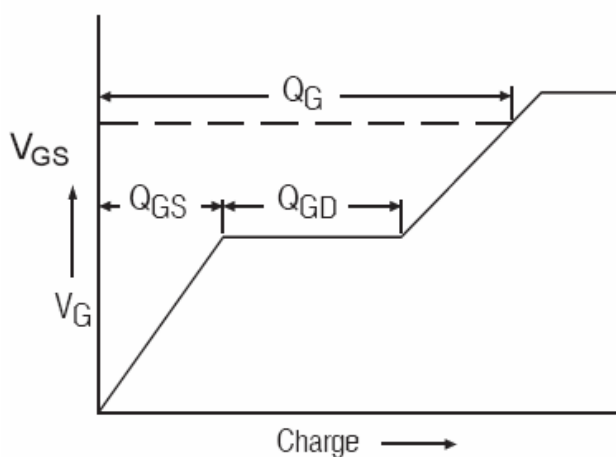
Figure 11: Normalized Maximum Transient Thermal Impedance

Test Circuit

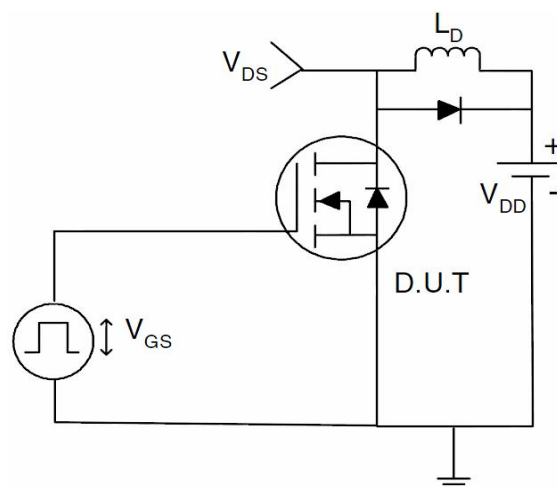
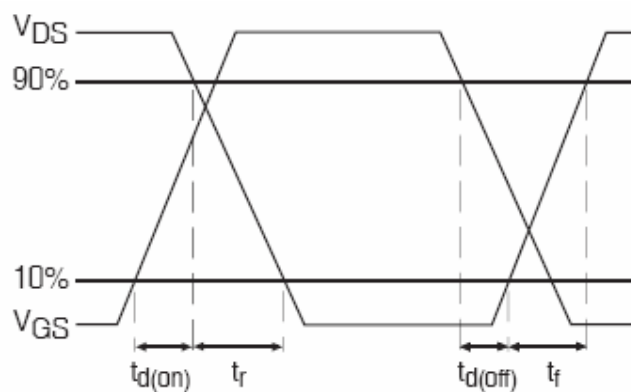
1) E_{AS} Test Circuits



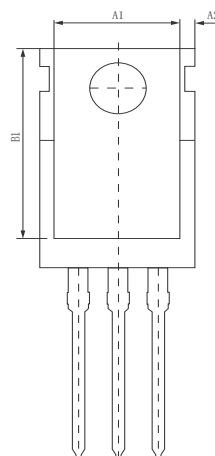
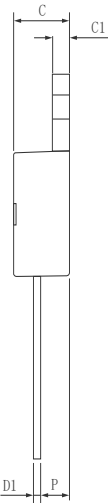
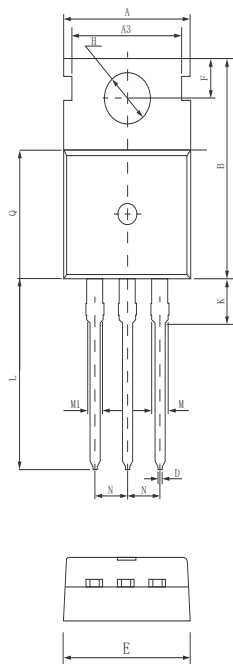
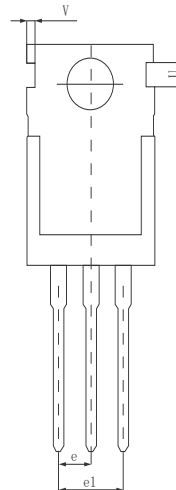
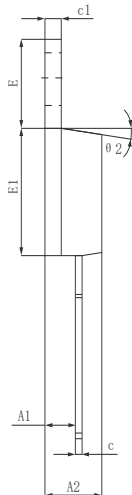
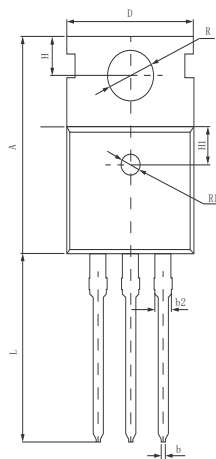
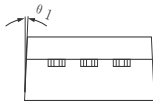
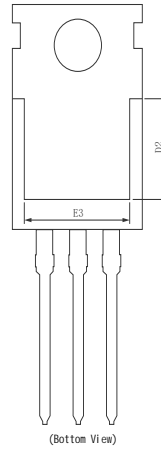
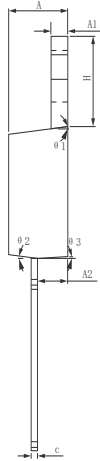
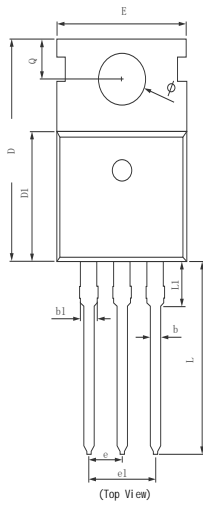
2) Gate Charge Test Circuit:



3) Switch Time Test Circuit:



•Dimensions (TO-220)



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	4.370	4.570	4.700
A1	1.250	1.300	1.400
A2	2.150	2.350	2.550
b	0.700	0.800	0.950
b1	1.170	1.270	1.470
c	0.450	0.500	0.600
D	15.100	15.600	16.100
D1	8.800	9.100	9.400
D2	5.500	6.300 REF	
E	9.700	10.000	10.300
E3	7.000	7.600 REF	
e	2.540 BSC		
e1	5.080 BSC		
L	13.200	13.500	13.800
L1		3.100	3.400
H	6.250	6.500	1.352
Φ	3.400	3.600	3.800
Q	2.600	2.800	3.000
θ 1	7° TYP		
θ 2	7° TYP		
θ 3	3° TYP		

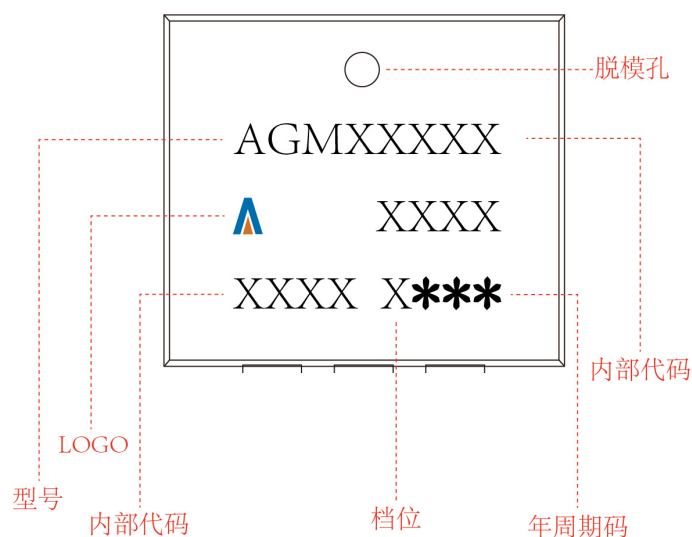
SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	15.400	15.600	15.800
A1	2.350	2.400	2.500
A2	4.400	4.500	4.700
b	0.700	0.800	0.900
b2	1.180	1.310	1.440
c	0.480	0.500	0.560
c1	1.290	1.300	1.320
D	9.800	10.000	10.200
E	6.400	6.500	6.600
E1	9.000	9.100	9.200
e	2.420	2.540	2.660
e1	4.840	5.080	5.320
H	2.730	2.800	2.870
H1	2.400	2.500	2.600
L	13.020	13.370	13.720
R	3.500	3.600	3.730
R1	1.400	1.500	1.600
U	1.650	1.750	1.850
V	0.580	0.680	0.780
θ 1	2°	2.5°	3°
θ 2	6.5°	7°	7.5°

Symbol	Dimensions (mm)
A	10.0±0.3
A1	8.0±0.2
A2	0.94±0.1
A3	8.7±0.1
B	15.6±0.4
B1	13.2±0.2
C	4.5±0.2
C1	1.3±0.2
D	0.8±0.2
D1	0.5±0.1
E	10.0±0.3
F	2.8±0.1
H	3.6±0.1
K	3.1±0.2
L	1.3±0.4
M	1.38±0.1
M1	1.28±0.1
N	2.54 (typ)
P	2.4±0.3
Q	9.15±0.25

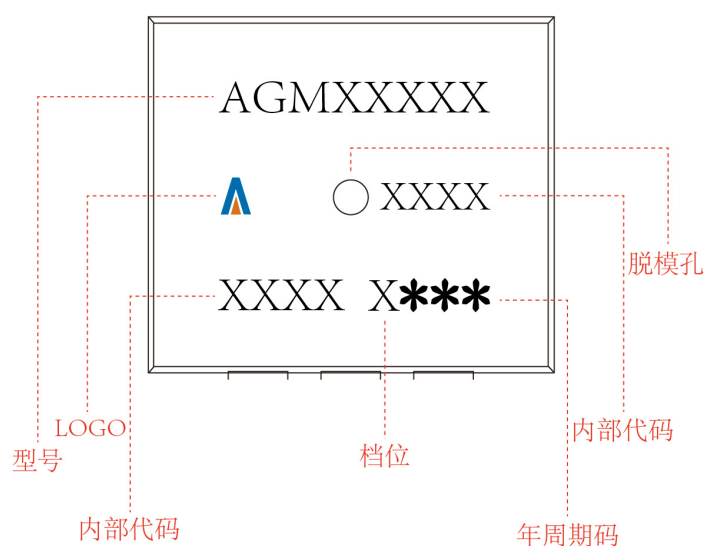
TO-220

Marking Instructions:

Model1:



Model2:




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